SONY

[Product Information]

Ver.1.0

IMX335LLN

Diagonal 6.52 mm (Type 1 / 2.8) CMOS Solid-state Image Sensor with Square Pixel for Monochrome Cameras

Description

The IMX335LLN is a diagonal 6.52 mm (Type 1 / 2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 5.14 M effective pixels. This chip operates with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved. This chip features an electronic shutter with variable charge-integration time. (Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- ♦ CMOS active pixel type dots
- Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 6 to 27 MHz / 37.125 MHz / 74.25 MHz
- ♦ Number of recommended recording pixels: 2592 (H) × 1944 (V) approx. 5.04 M pixels
- Readout mode
 - All-pixel scan mode
- Window cropping mode
- Vertical / Horizontal direction-normal / inverted readout mode
- Readout rate

Maximum frame rate in All-pixel scan mode 2592(H) x 1944(V) A/D 10-bit : 60 frame/s

High dynamic range (HDR) function

Multiple exposure HDR

Digital overlap HDR

- Variable-speed shutter function (resolution 1H units)
- 10-bit / 12-bit A/D converter
- CDS / PGA function
 0 dB to 30 dB : Analog Gain 30 dB (step pitch 0.3 dB)
 30.3 dB to 72 dB : Analog Gain 30 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)
- Supports I/O CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)
- ◆ Recommended exit pupil distance: -100 mm to -∞

STARVIS

* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 μ m² (color product, when imaging with a 706 cd/m² light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

Sony reserves the right to change products and specifications without prior notice. Sony logo is a registered trademark of Sony Corporation.

.

Device Structure

- CMOS image sensor
- ♦ Image size
- Total number of pixels
- Number of effective pixels
- Number of active pixels
- Number of recommended recording pixels
- Unit cell size
- Optical black
- ♦ Dummy
- Package

Type 1/2.8 2704 (H) × 2104 (V) approx. 5.69 M pixels 2616 (H) × 1964 (V) approx. 5.14 M pixels 2616 (H) × 1960 (V) approx. 5.13 M pixels 2592 (H) × 1944 (V) approx. 5.04 M pixels 2.0 μ m (H) × 2.0 μ m (V) Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 13 pixels, rear 0 pixel Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 0 pixel, rear 0 pixel 88 pin BGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks	
Sensitivity (F8)	Тур.	1961 Digit	1/30 s accumulation 12 bit converted value	
Saturation signal	Min.	3895 Digit	12 bit converted value	

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
All pixel	2592 (H) × 1944 (V) approx. 5.04 M pixels	60	CSI-2	10